

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of)	SEMICONDUCTOR PACKAGE AND
)	FABRICATION METHOD OF THE
Kye Chan Park)	SAME
)	
Divisional of)	Group Art Unit: 2815
Application No.: 10/167,702)	Examiner: Allan R. Wilson
)	

Filing Date: June 12, 2002

PRELIMINARY AMENDMENT

Commissioner for Patents
P.O. Box 1450
Mail Stop: DIVISIONAL PATENT APPLICATION
Alexandria, VA 22313-1450

Dear Sir:

Please amend the subject application as follows:

--CROSS REFERENCE TO RELATED APPLICATION

This application is a Divisional of U.S. patent application serial No. 10/167,702 entitled "SEMICONDUCTOR PACKAGE AND FABRICATION METHOD OF THE SAME", filed on June 12, 2002 which claims the priority of Korean patent application serial No. 2001-33946, filed June 15, 2001.--

Please delete claims 1-9 which were allowed in the parent application.

Please prosecute claims 10-20 in this application.